NXPSC10650B

Silicon Carbide Diode

Rev.03 - 06 May 2020

Product data sheet

1. General description

WeEn Semi

Silicon Carbide Schottky diode in a TO263 (D2PAK) plastic package, designed for high frequency switched-mode power supplies.



2. Features and benefits

- · Highly stable switching performance
- High forward surge capability I_{FSM}
- Extremely fast reverse recovery time
- Superior in efficiency to Silicon Diode alternatives
- Reduced losses in associated MOSFET
- Reduced EMI
- Reduced cooling requirements
- RoHS compliant

3. Applications

- Power factor correction
- Telecom / Server SMPS
- UPS
- PV inverter
- PC Silverbox
- LED / OLED TV
- Motor Drives

4. Quick reference data

Table 1. Q	uick reference data						
Symbol	Parameter	Conditions		Values			Unit
Absolute	maximum rating						
V_{RRM}	repetitive peak reverse voltage			650			V
$I_{F(AV)}$	average forward current	δ = 0.5 ; square-wave pulse; T _{mb} ≤ 112 °C; Fig. 1; Fig. 2; Fig. 3		10		A	
T _j	junction temperature			175		°C	
Symbol	Parameter	Conditions	Min Typ Max		Unit		
Static ch	aracteristics						
V _F	forward voltage	I _F = 10 A; T _j = 25 °C; <u>Fig. 5</u>		-	1.5	1.7	V
		I _F = 10 A; T _j = 150 °C; <u>Fig. 5</u>		-	1.8	2.1	V
Dynamic	characteristics	·		,			
Q _r	recovered charge	$I_F = 10 \text{ A}; \text{ d}I_F/\text{d}t = 500 \text{ A}/\mu\text{s}; \text{ V}_R = 400 \text{ V};$ $T_j = 25 \text{ °C}; \text{ Fig. 7}$		-	16	-	nC

5. Pinning information

Table 2. P	inning infor	mation		
Pin	Symbol	Description	Simplified outline	Graphic symbol
1	n.c.	not connected		
2	К	cathode [1]		K — A 001aaa020
3	А	anode	ii	
mb	К	mounting base; connected to cathode	TO-263 (D2PAK)	

[1] It is not possible to connect to pin 2 of the TO263 package.

6. Ordering information

Table 3. Ordering information								
Type number	Package name	Orderable part number	Packing method	Small packing quantity	Package version	Package issue date		
NXPSC10650B	TO263	NXPSC10650B6J	Reel	800	TO263N	26-Sep-2016		

7. Marking

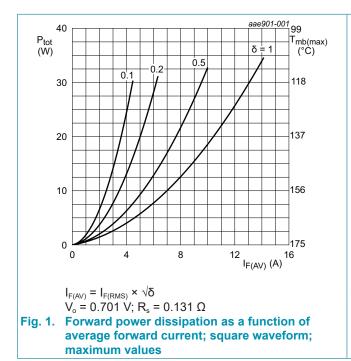
Table 4. Marking codes						
Type number	Marking codes					
NXPSC10650B	NXPSC 10650B					

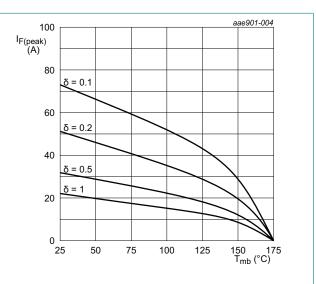
8. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

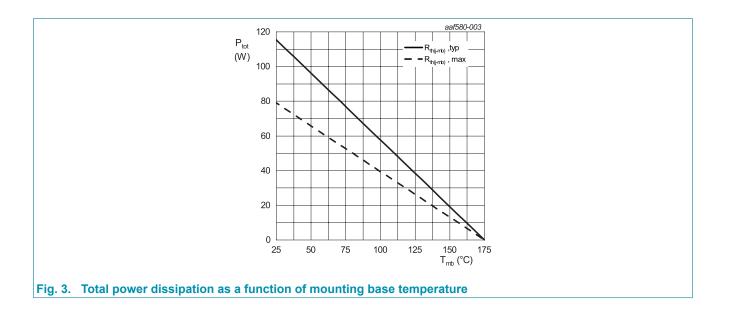
Symbol	Parameter	Conditions	Values	Unit
V_{RRM}	repetitive peak reverse voltage		650	V
V_{RWM}	crest working reverse voltage		650	V
V _R	reverse voltage	DC	650	V
I _{F(AV)}	average forward current	δ = 0.5; square-wave pulse; T _{mb} ≤ 112 °C; Fig. 1; Fig. 2; Fig. 3	10	A
I _{FRM}	repetitive peak forward current	δ = 0.5; t _p = 25 μs; T _{mb} ≤ 112 °C; square-wave pulse	20	A
I _{FSM}	non-repetitive peak	t_p = 10 ms; $T_{j(init)}$ = 25 °C; sine-wave pulse	50	А
	forward current	t_p = 10 µs; $T_{j(init)}$ = 25 °C; square-wave pulse	450	А
l ² t	I ² t for fusing	sine-wave pulse; $T_{j(init)}$ = 25 °C; t_p = 10 ms	12.5	A ² s
T _{stg}	storage temperature		-55 to 175	°C
T _j	junction temperature		175	°C





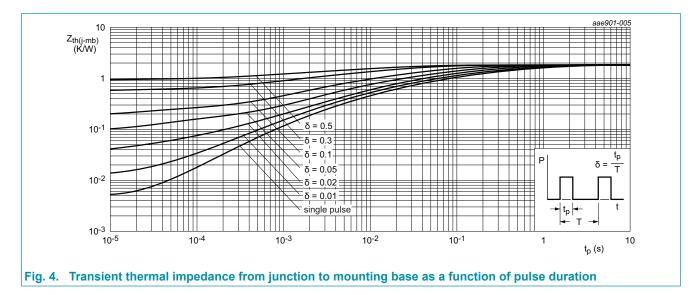


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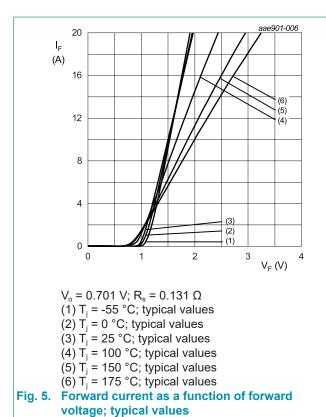
9. Thermal characteristics

Table 6. Th	ermal characteristics					
Symbol	Parameter	Conditions	Min	Тур	Мах	Unit
$R_{\text{th(j-mb)}}$	thermal resistance from junction to mounting base	with heatsink compound; Fig. 4	-	1.3	1.9	K/W
$R_{\text{th(j-a)}}$	thermal resistance from junction to ambient free air	in free air	-	60	-	K/W



10. Characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Static cha	aracteristics	· · · · · · · · · · · · · · · · · · ·				
V _F	forward current	I _F = 10 A; T _j = 25 °C; <u>Fig. 5</u>	-	1.5	1.7	V
		I _F = 10 A; T _j = 150 °C; <u>Fig. 5</u>	-	1.8	2.1	V
I _R	reverse current	V _R = 650 V; T _j = 25 °C; <u>Fig. 6</u>	-	-	60	μA
		V _R = 650 V; T _j = 150 °C; <u>Fig. 6</u>	-	-	240	μA
Dynamic	characteristics		I			,
Q _r	recovered charge	I _F = 10 A; V _R = 400 V; dI _F /dt = 500 A/μs; T _j = 25 °C; <u>Fig. 7</u>	-	16	-	nC
C _d	diode capacitance	f = 1 MHz; V _R = 1 V; T _j = 25 °C	-	328	-	pF
		f = 1 MHz; V _R = 300 V; T _j = 25 °C	-	44	-	pF
		f = 1 MHz; V _R = 600 V; T _j = 25 °C	-	42	-	pF
E _{as}	non-repetitive	I _R = 5.5 A; L = 5 mH; T _{j(init)} = 25 °C	75	-	-	mJ
	avalanche energy					



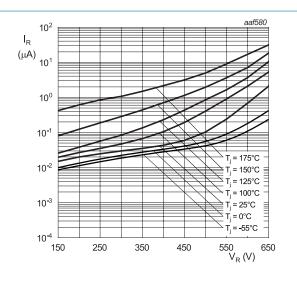
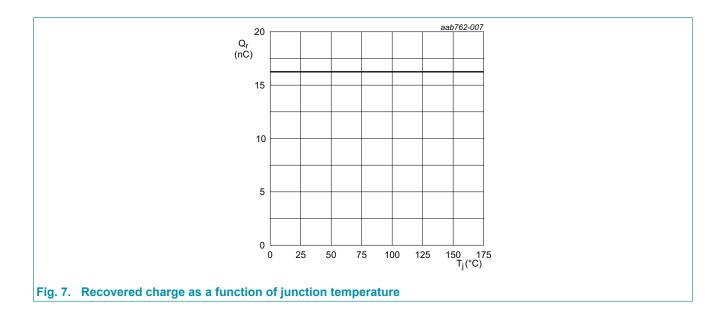
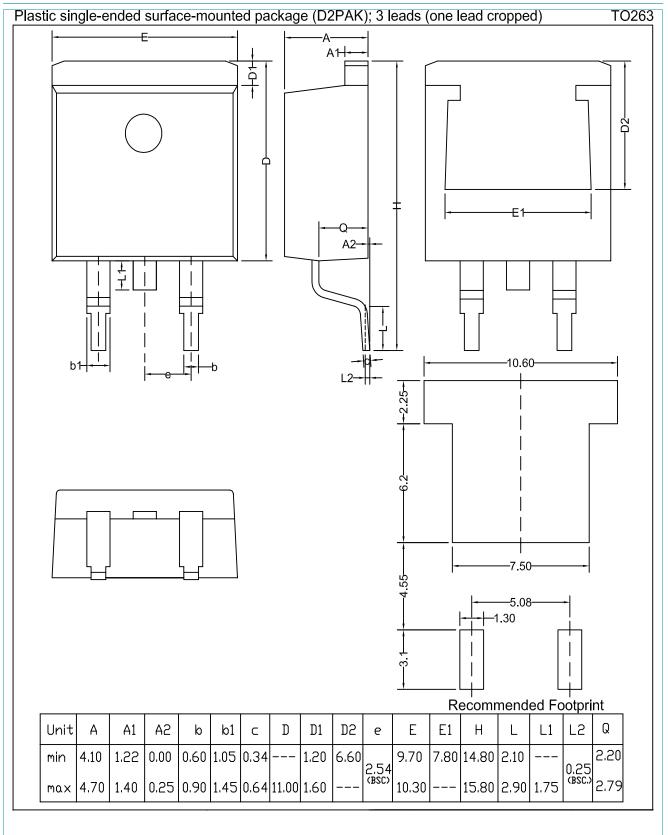


Fig. 6. Reverse leakage current as a function of reverse voltage; typical value

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11. Package outline



NXPSC10650B **Product data sheet**

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12. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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- The term 'short data sheet' is explained in section "Definitions". [2]
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